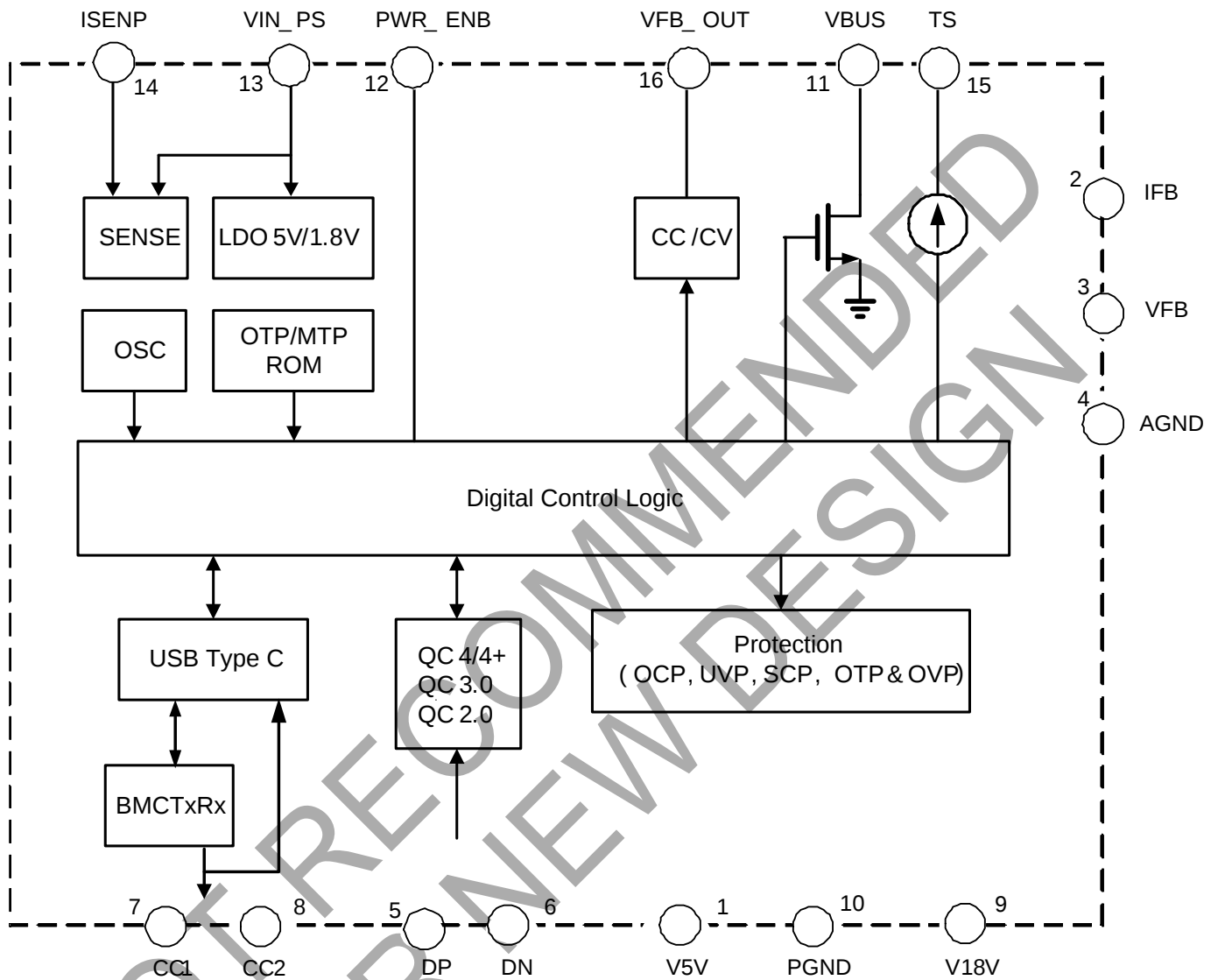


Pin Number	Pin Name	Description
1	V5V	LDO5V Output, 10μF to GND
2	IFB	CC Input. Negative Node of CC OPAM for Photocoupler
3	VFB	CV Input. Negative Node of CV OPAM for Photocoupler
4	AGND	Ground
5	DP	USB D+ Input
6	DN	USB D- Input
7	CC1	Type-C_CC1
8	CC2	Type-C_CC2
9	V18V	LDO1.8V Output, 0.1μF to GND
10	PGND	Ground
11	VBUS	VBUS Terminal for Discharge Path
12	PWR_ENB	External PMOS Gate Driver. To Control External MOS Switch: 0: To Enable VBUS Voltage 1: Disconnect VBUS
13	VIN_PS	High Voltage Power Input (V _{MAX} = 32V)
14	ISENP	Input Current Sense Positive Node
15	TS	Source Current (100μA) to External NTC Sensor for External OTP (Over Temperature Protection)
16	VFB_OUT	CC / CV Output. Open-Drain Output for Photocoupler (For Example, TL431)

Functional Block Diagram



Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.) (Note 4)

Parameter	Rating	Unit
VIN_PS, VBUS, ISEN, PWR_ENB, VFB_OUT, TS Voltage	-0.3 to 32	V
V5V, IFB, VFB, DP, DN, CC1, CC2 Voltage	-0.3 to 7	V
V18V Voltage	-0.3 to 3.6	V
ESD (Human Body Model) Voltage on DP, DN, CC1, CC2 Pins	4	kV
ESD (Human Body Model) Voltage on VIN_PS, VBUS, ISEN, PWR_ENB, VFB_OUT, TS, V5V, IFB, VFB, V18V Pins	2	kV
Maximum Junction-to-Ambient Thermal Resistance	113	$^\circ\text{C/W}$
Maximum Junction-to-Case Thermal Resistance	34	$^\circ\text{C/W}$
Operating Junction Temperature Range	-40 to +150	$^\circ\text{C}$
Storage Temperature Range	-40 to +150	$^\circ\text{C}$

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods can affect device reliability.

Recommended Operating Conditions (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
VIN_PS	Power Supply Voltage	0	25	V
TOP	Operating Temperature Range	-40	+85	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Parameter	Test Conditions	Min	Typ	Max	Unit
UVLO Voltage	VIN_PS Rising	—	2.8	—	V
UVLO Hysteresis Voltage	VIN_PS Falling	—	2.7	—	V
V5V Voltage	VIN_PS = 6V	—	5	—	V
V5V Output Current Limit	—	—	70	—	mA
V18V Voltage	—	—	1.8	—	V
VIN_PS Current in Sleep Mode	CC1/2 Detach after 3s	—	550	—	μA
VIN_PS Current in Normal Mode	VIN_PS = 5V	—	4.5	—	mA
Internal CLK in Normal Mode	—	—	12	—	MHz
VIN_PS_OVP Voltage	—	110	120	130	%VIN_PS
VIN_PS_UVP Voltage	—	—	75	—	%VIN_PS
I_OCP Current	I_MAX = Setting Maximum Current	—	30	—	%I_MAX
OCP Deglitch Time	—	90	—	110	ms
Internal OTP	—	—	+140	—	$^\circ\text{C}$
External OTP Current	—	—	100	—	μA

Performance Characteristics

The AP43770 includes a USB Type-C power delivery controller, which meets USB Power Delivery specification Rev3.0 v1.1. Because of its high voltage process, the AP43770 provides a cost-effective solution without requiring external discrete high voltage components, such as LDO, TL431, CC/CV, pre-driver for external PMOS power switch, buck or boost converter, etc. Meanwhile, it can provide robust protection scheme with built-in OVP/OCP/SCP/OTP features. What's more, it supports on-chip multi-time-programmable (MTP) for maximum four times during the configuration and ID data programming.

In consideration of the quick charge protocol migrating in portable device, the AP43770 supports options for QC4/4+, QC3.0/2.0 and BC 1.2. All of these protocols can be turned on or off and identified automatically. It can be configured with practical applications of users.

System Power-On Sequence

When the external power source is provided, the AP43770 wakes up after the power-on reset ($V_{RST} \sim 2.8V$), then the internal 5V_LDO and 1.8V_LDO are settled, and the USB PD controller and MCU would be initialized. All analog control blocks are ready and waiting for PD negotiation process. Meanwhile, the AP43770 monitors the voltage and current conditions to avoid abnormal conditions. Once any unacceptable conditions happen, the AP43770 goes into protection procedure according to the types of abnormal condition.

Voltage Transition

According to the USB PD's protocol, once the PD device requests different power profiles, the AP43770's power control block starts to change the voltage and current values. The AP43770 provides corresponding Over-Voltage Protection (OVP), Over-Current Protection (OCP) schemes, and maintains the feedback system stability to guarantee monotonic voltage transition and avoid violating the USB PD electrical specification.

The AP43770 provides zero-mismatch voltage methodology which is more flexible for system design requirements of customers. When UFP/DFP makes an acceptable power request deal, the AP43770 changes VFB voltage according to the USB PD command, which is around 1/10 of expected voltage. The voltage regulator control loop (AC/DC or DC/DC) regulates the required V_{BUS} voltage according to V_{FB} voltage. In addition, the shunt regulator is built in to minimize the total external components and the cost.

Protection

The AP43770 supports OVP/UVP/OCP/SCP/OTP and Constant Current (CC) functions. All of the protection thresholds would depend on the requested power profile and provide the most reliable protection scheme.

The AP43770 provides the OVP feature by turning off the power switch when V_{BUS} is 20% higher than the target voltage. Meanwhile, it provides internal discharge path to reduce the overvoltage duration, and terminates discharge current as soon as V_{BUS} reaches the target voltage. To avoid the V_{BUS} working abnormally, the AP43770 provides UVP function if the V_{BUS} is below 75% of the target voltage.

To ensure the USB PD safe operation, the AP43770 supports programmable OCP function to make sure output current would not be higher than the allowed maximum current. Once unacceptable conditions happen, the AP43770 would shut down the USB PD system and send "Hard Reset" to the UFP device.

CV/CC

The AP43770 supports Constant Voltage (CV) and Constant Current (CC) functions. The functions can control the output voltage and current by the control pin VFB_OUT and the feedback pins VFB and IFB. During the CV mode, the AP43770 operates in the fixed PDO, and the output voltage will be regulated to the request voltage if the output current is below the allowed maximum current. Once the sink device draws more than I_{OCP} , overcurrent protection occurs. When the CC mode function is enabled, the output voltage drops, and the source current is limited within 150mA of the requested current whenever output current exceeds the allowed maximum current. When the output voltage drops below UVP, constant current limit turns off V_{BUS} and starts error recovery procedure. The AP43770 will reset if the voltage continues dropping to power-on-reset (POR) threshold.

Performance Characteristics (continued)

Figure 1 and Figure 2 show V/I profile of this CC/CV functions.

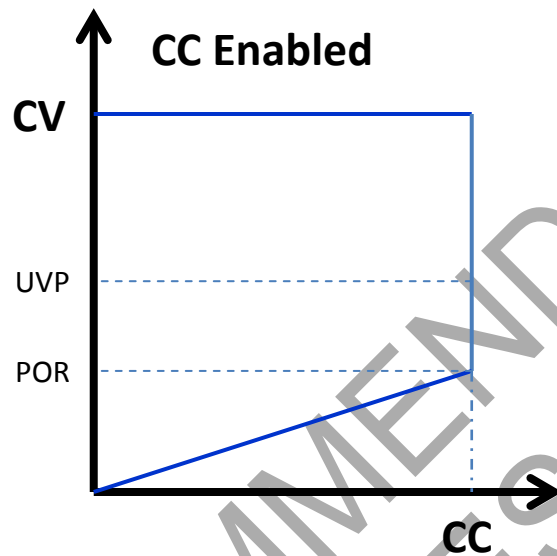


Figure 1. AP43770 V/I Profile When CC Enabled

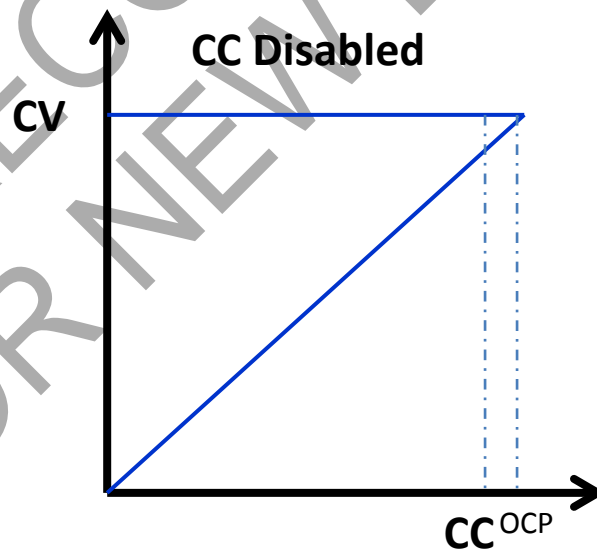
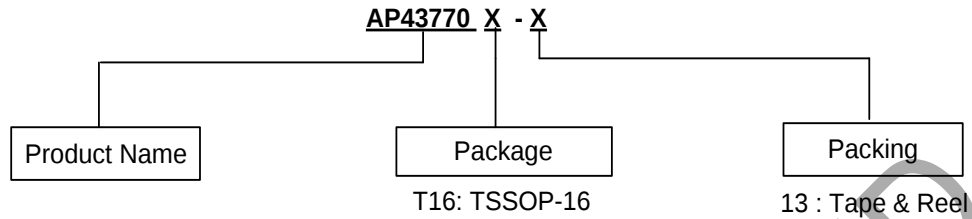


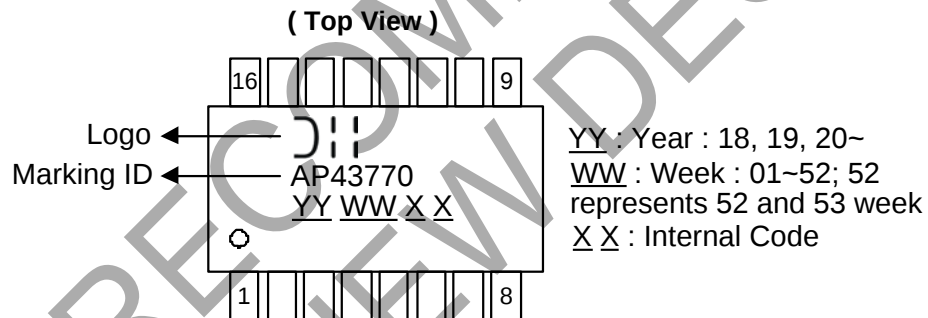
Figure 2. AP43770 V/I Profile When CC Disabled

Ordering Information



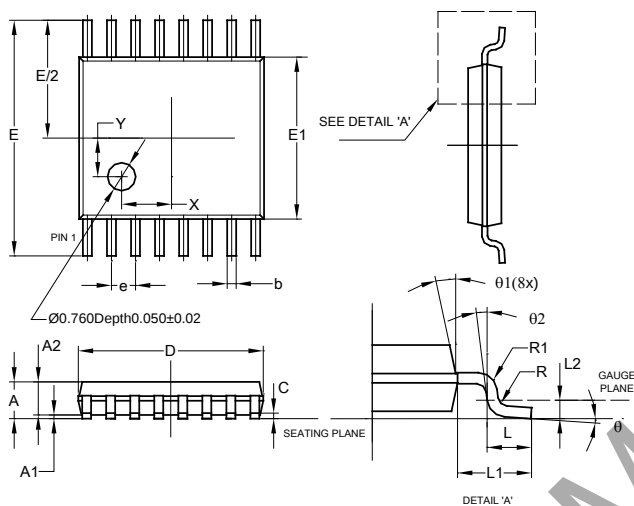
Part Number	Package	Marking ID	13" Tape and Reel	
			Quantity	Part Number Suffix
AP43770T16-13	TSSOP-16	AP43770	4000/Tape and Reel	-13

Marking Information



Package Outline Dimensions (All dimensions in mm.)

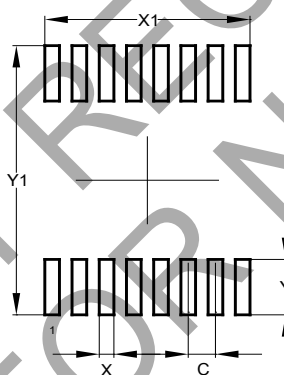
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



TSSOP-16			
Dim	Min	Max	Typ
A	—	1.20	—
A1	0.05	0.15	—
A2	0.80	1.05	—
b	0.19	0.30	—
c	0.09	0.20	—
D	4.90	5.10	—
E	6.40 BSC		
E1	4.30	4.50	—
e	0.65 BSC		
L	0.45	0.75	—
L1	1.00 REF		
L2	0.25 BSC		
R / R1	0.09	—	—
X	—	—	1.350
Y	—	—	1.050
θ	0°	8°	—
$\theta 1$	5°	15°	—
$\theta 2$	0°	—	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	0.650
X	0.350
X1	4.900
Y	1.400
Y1	6.800

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